

No-Clean Solder Wire

Sn96.5/Ag3/Cu0.5, 500 g, 1 mm



FEATURES:

SPECIFICATION:

| | |
|----------------------|------------------|
| Alloy | Sn96.5/Ag3/Cu0.5 |
| Flux | B 2.1 |
| Proportion of flux | 2.5 % |
| Solder wire diameter | 1 mm |
| Weight | 500 g |
| Melting point | +217 °C |

Art. Nr.

RND 560-00183

